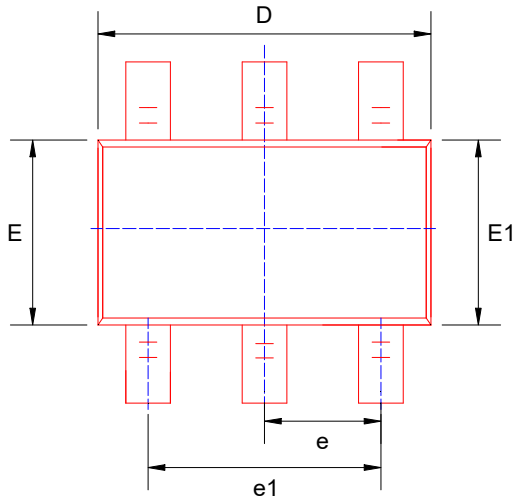
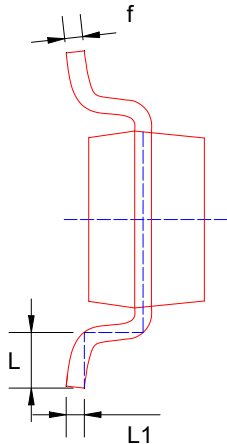


	深圳市锐骏半导体有限公司 ShenZhen Ruichips Semiconductor CO.,LTD	编号	RU-001-SOT23-6-A-001
	封装外形尺寸（POD）规范	版本	A/0
		页次	13

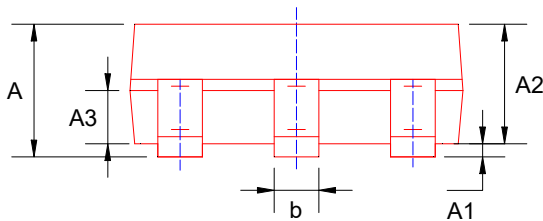
SOT23-6



TOP VIEW
正视图



SIDE VIEW
侧视图



SIDE VIEW
侧视图

- NOTE:
- 1: ALL UNITS ARE IN MILLIMETER.
 - 2: EJECTOR PIN MARK POSITION MAY VARY FROM DIFFERENT MOLD.
 - 3: ALL DIMENSIONS REFER TO JEDEC.DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
A	—	—	1.300			0.051
A1	0.050	0.070	0.110	0.002	0.003	0.004
A2	1.050	1.100	1.150	0.041	0.043	0.045
A3	0.600	0.650	0.700	0.024	0.026	0.028
b	0.350	0.400	0.450	0.014	0.016	0.018
e	0.920	0.950	0.980	0.036	0.037	0.039
e1	1.850	1.900	1.950	0.073	0.075	0.077
D	2.820	2.870	2.920	0.111	0.113	0.115
E	2.650	2.800	2.950	0.104	0.110	0.116
E1	1.550	1.600	1.650	0.061	0.063	0.065
L	0.400	0.450	0.500	0.016	0.018	0.020
f	0.065	0.125	0.185	0.003	0.005	0.007
L1	0.25BSC			0.010BSC		